GBU6005 THRU GBU610

Glass Passivated Single-phase Bridge Rectifiers

Reverse Voltage - 50 to 1000 V

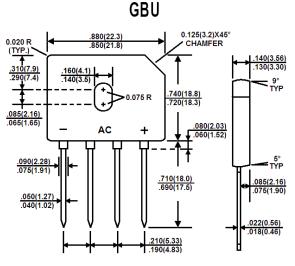
Forward Current - 6 A

Features

- Plastic material has Underwriters Laboratory Flammability Classification 94V-0
- · Ideal for printed circuit boards
- · Glass passivated chip junction
- Reliable low cost construction utilizing molded plastic technique

Mechanical Data

- · Case: Molded plastic, GBU
- **Terminals:** leads solderable per MIL-STD-202 Method 208 guaranteed
- Mounting Position: Any



Dimensions in millimeters

Maximum Ratings and Electrical Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, resistive or inductive load, for capacitive load, derate by 20%

Parameter	Symbols	GBU6005	GBU601	GBU602	GBU604	GBU606	GBU608	GBU610	Unit
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_c = 100 \circ C^{(1), 2)}$	I _{F(AV)}	6							А
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	175							А
Maximum Forward Voltage at 3 A	VF	1							V
Maximum Reverse Currentat $T_A = 25 ^{\circ}C$ at Rated DC Blocking Voltage $T_A = 125 ^{\circ}C$	I _R	5 500							μA
Typical Junction Capacitance ³⁾	CJ	210			94			pF	
Typical Thermal Resistance ^{1), 2)}	$R_{\theta JA}$	7.4							°C/W
Typical Thermal Resistance ^{1), 2)}	R _{θJC}	2.2							°C/W
Operating and Storage Temperature Range	T_{j}, T_{stg}	- 55 to + 150							°C

 $^{1)}$ Units case mounted on 2.6 X 1.4 X 0.06" thick (6.5 X 3.5 X 0.15 cm) AI. plate heatsink..

²⁾ Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screws. ³⁾ Measured at 1 MHz and applied reverse voltage of 4.0 VDC.



